

GS1A THRU GS1M

SURFACE MOUNT GLASS PASSIVATED RECTIFIER

VOLTAGE: 50 TO 1000V

CURRENT: 1.0A



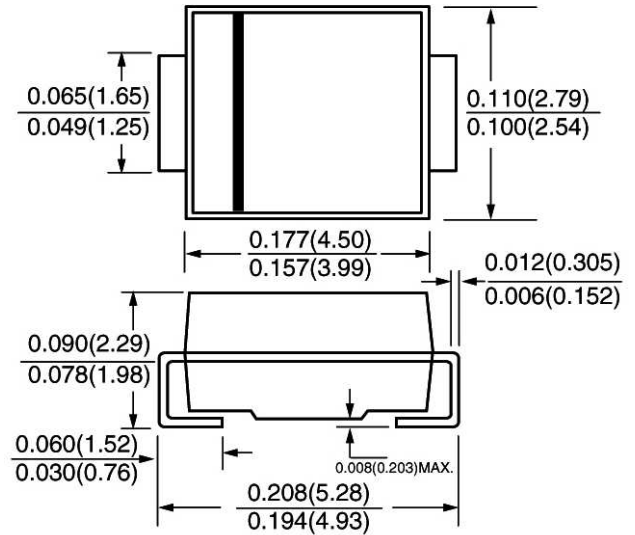
FEATURE

Ideal for surface mount pick and place application
 Low profile package
 Built-in strain relief
 High surge capability
 High temperature soldering guaranteed
 260°C/10sec/at terminals

MECHANICAL DATA

Terminal: Plated axial leads solderable per
 MIL-STD 202E, method 208C
 Case: Molded with UL-94 class V-0 recognized Flame
 Retardant Epoxy
 Polarity: color band denotes cathode

SMA / DO-214AC



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated,
 for capacitive load, derate current by 20%)

	SYMBOL	GS 1A	GS 1B	GS 1D	GS 1G	GS 1J	GS 1K	GS 1M	units
Maximum Recurrent Peak Reverse Voltage	V _{rrm}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{rms}	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	V _{dc}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current 3/8" lead length at T _L =100°C	I _{f(av)}	1.0							A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{fsm}	30.0							A
Maximum Instantaneous Forward Voltage at rated Forward current	V _f	1.1							V
Maximum DC Reverse Current Ta =25°C at rated DC blocking voltage Ta =125°C	I _r	5.0 200.0							μ A μ A
Typical Junction Capacitance (Note 1)	C _j	15.0							pF
Typical Thermal Resistance (Note 2)	R(jl)	30.0							°C/W
Storage and Operating Junction Temperature	T _{stg}	-50 to +150							°C

Note:

1. Measured at 1.0 MHz and applied voltage of 4.0Vdc
2. Thermal Resistance from Junction to terminal mounted on 5×5mm copper pad area¹

Fig. 1 – Forward Current Derating Curve

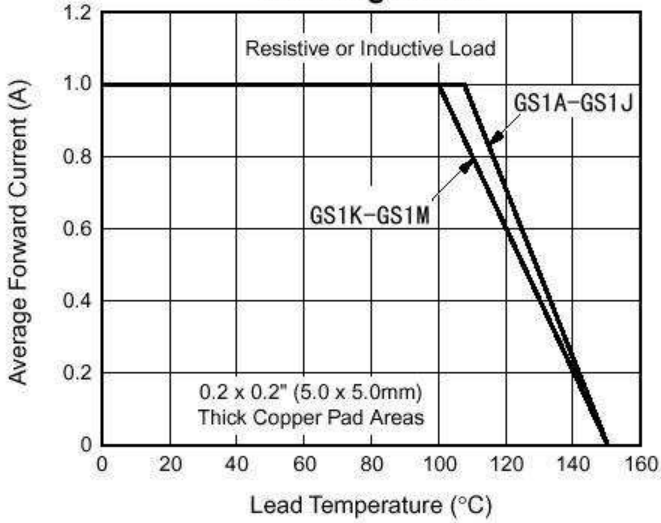


Fig. 2 – Maximum Non-Repetitive Peak Forward Surge Current

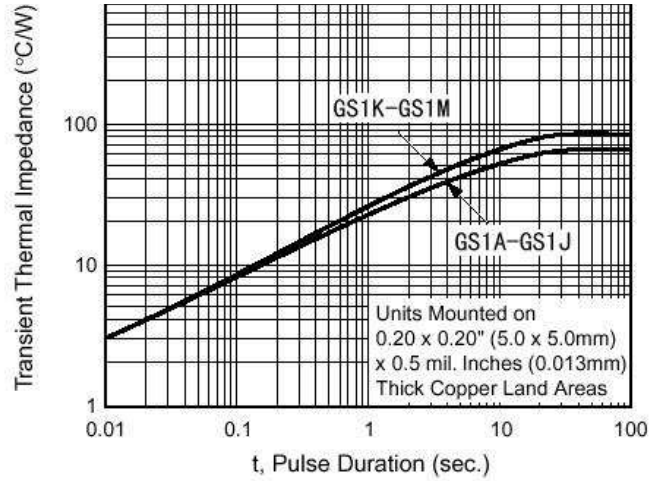
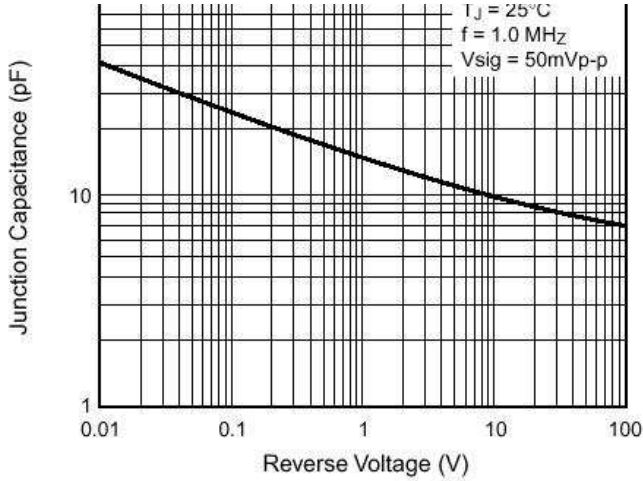
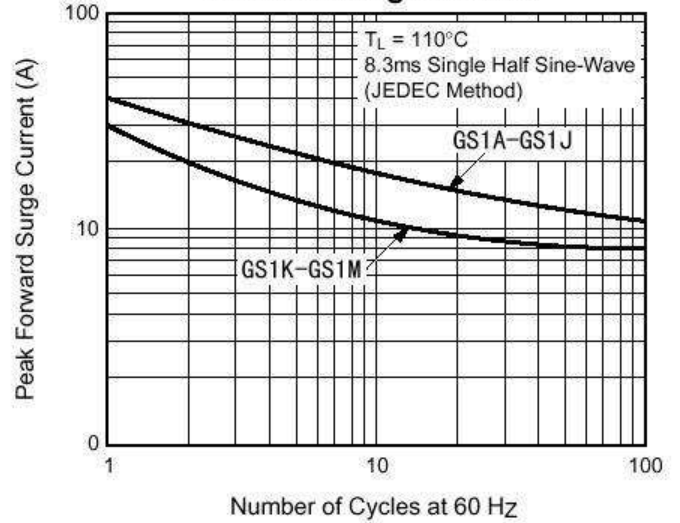


Fig. 3 – Typical Instantaneous Forward Characteristics

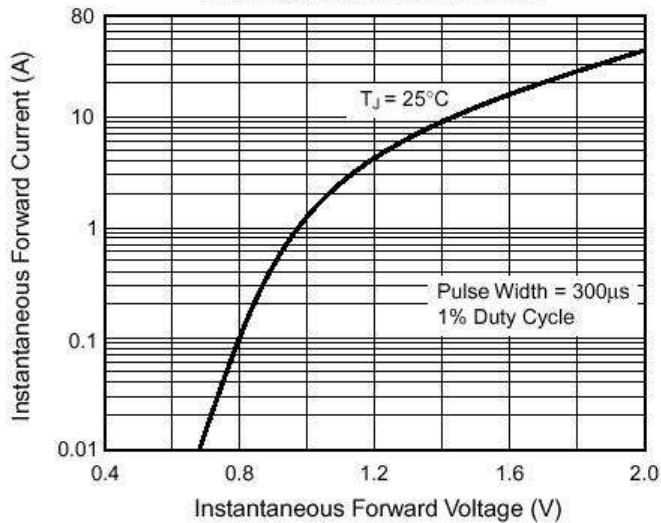


Fig. 4 – Typical Reverse Leakage Characteristics

